

# **PMBT3904VS**

# 40 V, 200 mA NPN/NPN switching transistor Rev. 01 — 8 July 2009

**Product data sheet** 

### 1. Product profile

### 1.1 General description

NPN/NPN double switching transistor in a SOT666 ultra small and flat lead Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number			PNP/PNP	NPN/PNP
	NXP	JEITA	complement	complement
PMBT3904VS	SOT666	-	PMBT3906VS	PMBT3946VPN

#### 1.2 Features

- Double general-purpose switching transistor
- Board-space reduction
- Ultra small and flat lead SMD plastic package

### 1.3 Applications

■ General-purpose switching and amplification

#### 1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
$V_{CEO}$	collector-emitter voltage	open base	-	-	40	V
I <sub>C</sub>	collector current		-	-	200	mA
h <sub>FE</sub>	DC current gain	$V_{CE} = 1 V;$ $I_{C} = 10 \text{ mA}$	100	180	300	



### 2. Pinning information

Table 3. Pinning

Table 3.	Filling		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1	6 5 4	6 5 4
3	collector TR2		TR2
4	emitter TR2		(TR1)
5	base TR2	1 2 3	
6	collector TR1	1 2 3	1 2 3
			sym020

# 3. Ordering information

Table 4. Ordering information

Type number	Package				
	Name	Description	Version		
PMBT3904VS	-	plastic surface-mounted package; 6 leads	SOT666		

### 4. Marking

Table 5. Marking codes

Type number	Marking code
PMBT3904VS	ZC

# 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter Conditions		Min	Max	Unit		
Per transistor							
$V_{CBO}$	collector-base voltage	open emitter	-	60	V		
$V_{CEO}$	collector-emitter voltage	open base	-	40	V		
$V_{EBO}$	emitter-base voltage	open collector	-	6	V		
I <sub>C</sub>	collector current		-	200	mA		
I <sub>CM</sub>	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA		
I <sub>BM</sub>	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	100	mA		
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	[1][2]	240	mW		
Per devic	e						
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1][2]	360	mW		

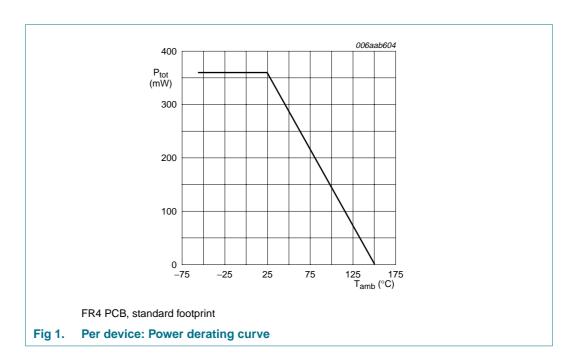
 Table 6.
 Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$T_j$	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.



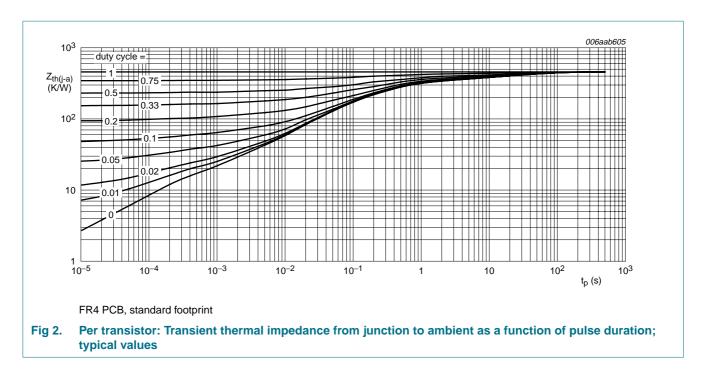
### 6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1][2]	-	521	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	100	K/W
Per devic	е					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1][2] _	-	347	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

<sup>[2]</sup> Reflow soldering is the only recommended soldering method.



### 7. Characteristics

Table 8. Characteristics

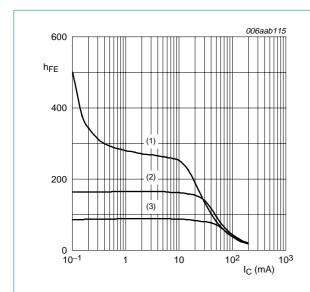
 $T_{amb}$  = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	50	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 6 \text{ V}; I_{C} = 0 \text{ A}$	-	-	50	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 1 V				
		$I_C = 0.1 \text{ mA}$	60	180	-	
		$I_C = 1 \text{ mA}$	80	180	-	
		I <sub>C</sub> = 10 mA	100	180	300	
	$I_C = 50 \text{ mA}$	60	105	-		
		I <sub>C</sub> = 100 mA	30	50	-	
V <sub>CEsat</sub>	collector-emitter	$I_C = 10 \text{ mA}; I_B = 1 \text{ mA}$	-	75	200	mV
	saturation voltage	$I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$	-	120	300	mV
$V_{BEsat}$	base-emitter	$I_C = 10 \text{ mA}; I_B = 1 \text{ mA}$	650	750	850	mV
	saturation voltage	$I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$	-	850	950	mV
$t_d$	delay time	$V_{CC} = 3 \text{ V}; I_{C} = 10 \text{ mA};$	-	-	35	ns
t <sub>r</sub>	rise time	$I_{Bon} = 1 \text{ mA};$ $I_{Boff} = -1 \text{ mA}$	-	-	35	ns
t <sub>on</sub>	turn-on time		-	-	70	ns
t <sub>s</sub>	storage time		-	-	200	ns
t <sub>f</sub>	fall time		-	-	50	ns
t <sub>off</sub>	turn-off time		-	-	250	ns

Table 8. **Characteristics** ...continued

$T_{amb}$ = 25 °C unless otherwise specified.
---

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>c</sub>	collector capacitance	$V_{CB} = 5 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	4	pF
C <sub>e</sub>	emitter capacitance	$V_{EB} = 500 \text{ mV};$ $I_{C} = i_{c} = 0 \text{ A}; f = 1 \text{ MHz}$	-	-	8	pF
f <sub>T</sub>	transition frequency	$V_{CE} = 20 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz	300	-	-	MHz
NF	noise figure	$V_{CE}$ = 5 V; $I_{C}$ = 100 μA; $R_{S}$ = 1 kΩ; f = 10 Hz to 15.7 kHz	-	-	5	dB



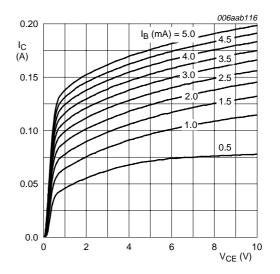


<sup>(1)</sup>  $T_{amb} = 150 \, ^{\circ}C$ 

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

Fig 3. Per transistor: DC current gain as a function of collector current; typical values



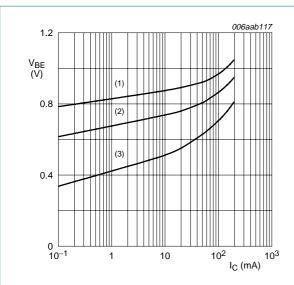
 $T_{amb} = 25 \, ^{\circ}C$ 

Fig 4. Per transistor: Collector current as a function of collector-emitter voltage; typical values

5 of 11

# **PMBT3904VS**

#### 40 V, 200 mA NPN/NPN switching transistor



$$V_{CE} = 1 V$$

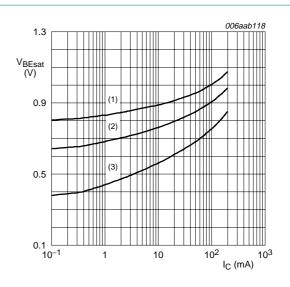
(1) 
$$T_{amb} = -55 \,^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3)  $T_{amb} = 150 \, ^{\circ}C$ 

Fig 5. Per transistor:

Base-emitter voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

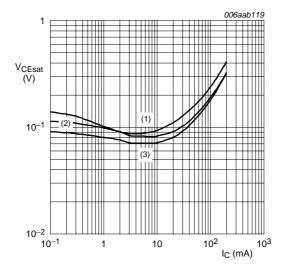
(1) 
$$T_{amb} = -55 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 150 \, ^{\circ}C$$

Fig 6. Per transistor:

Base-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B}=10$$

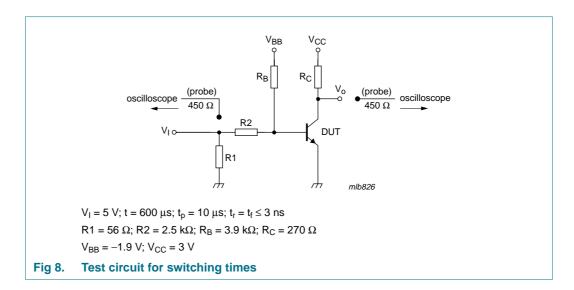
(1)  $T_{amb} = 150 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

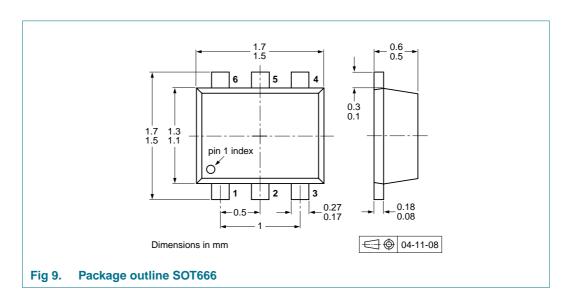
(3)  $T_{amb} = -55 \, ^{\circ}C$ 

Fig 7. Per transistor: Collector-emitter saturation voltage as a function of collector current; typical values

### 8. Test information



# 9. Package outline



### 10. Packing information

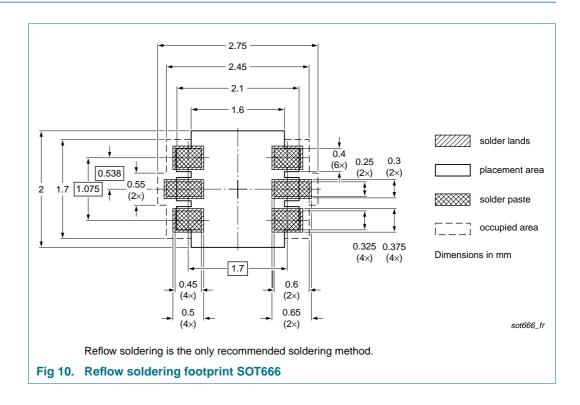
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantit		quantity
		4000	8000		
PMBT3904VS	PMBT3904VS SOT666	2 mm pitch, 8 mm tape and reel		-	-315
		4 mm pitch, 8 mm tape and reel		-115	-

<sup>[1]</sup> For further information and the availability of packing methods, see Section 14.

### 11. Soldering





# 12. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMBT3904VS_1	20090708	Product data sheet	-	-

### 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

#### 13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

#### 13.3 Disclaimers

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

#### 13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

#### 14. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

PMBT3904VS\_1 © NXP B.V. 2009. All rights reserved.

# **PMBT3904VS**

### 40 V, 200 mA NPN/NPN switching transistor

### 15. Contents

1	Product profile
1.1	General description
1.2	Features
1.3	Applications
1.4	Quick reference data
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values
6	Thermal characteristics 3
7	Characteristics 4
8	Test information 7
9	Package outline 7
10	Packing information 8
11	Soldering 8
12	Revision history 9
13	Legal information
13.1	Data sheet status
13.2	Definitions
13.3	Disclaimers
13.4	Trademarks10
14	Contact information 10
15	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

